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(12) **United States Design Patent**  
**Zhou**

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(54) **LIGHT EMITTING DIODE MODULE**

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(73) Assignee: **Lextar Electronics Corp.**, Hsinchu (TW)

(\*\*) Term: **14 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (9) Cl.** ..... **13-03**

(52) **U.S. Cl.**  
USPC ..... **D13/180**

(58) **Field of Classification Search**  
USPC ..... D13/180; D26/1; 257/79, 80, 81,  
257/88, 89, 95, 98, 99, 100, E33.058; 313/483,  
313/498, 500; 362/555, 800  
See application file for complete search history.

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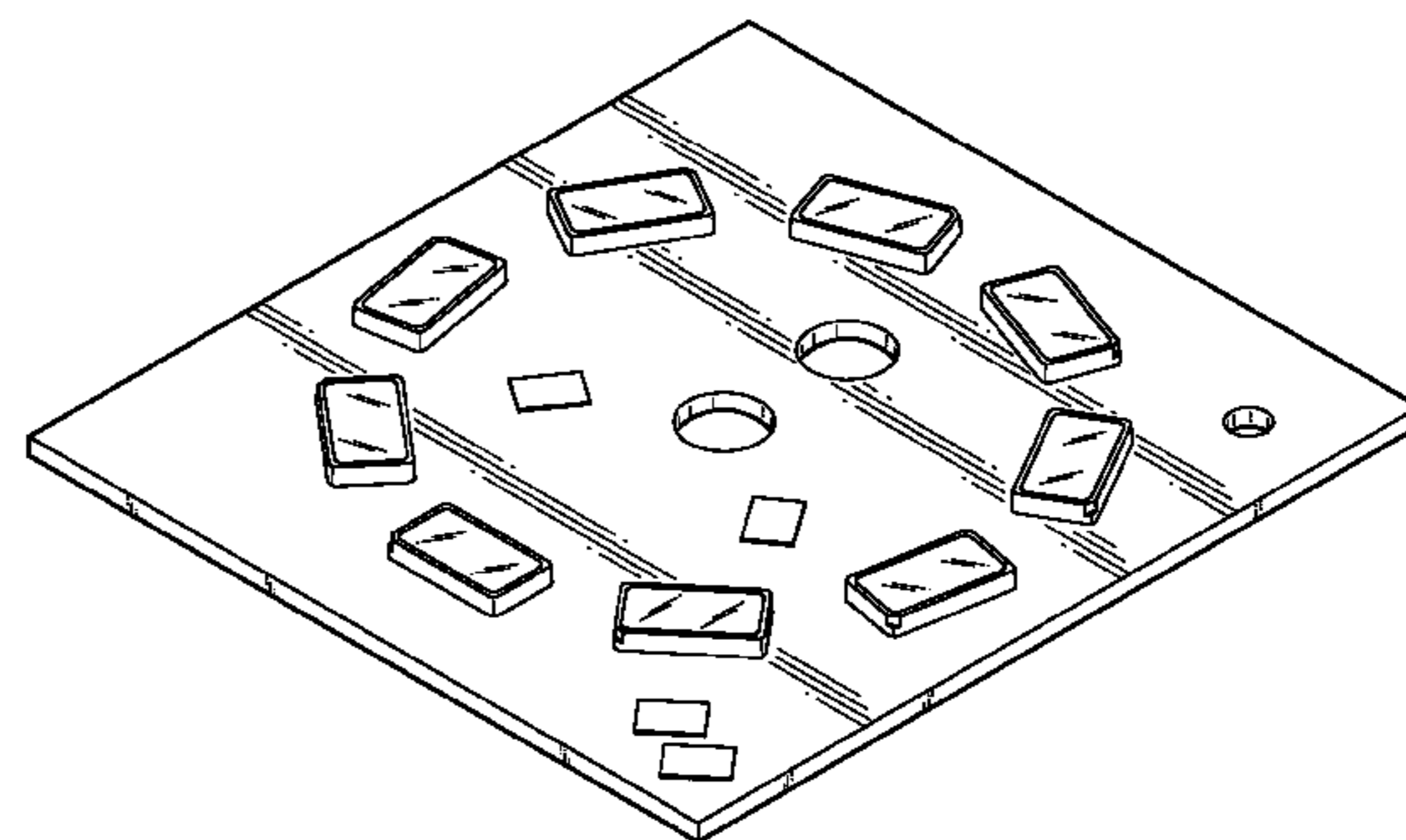
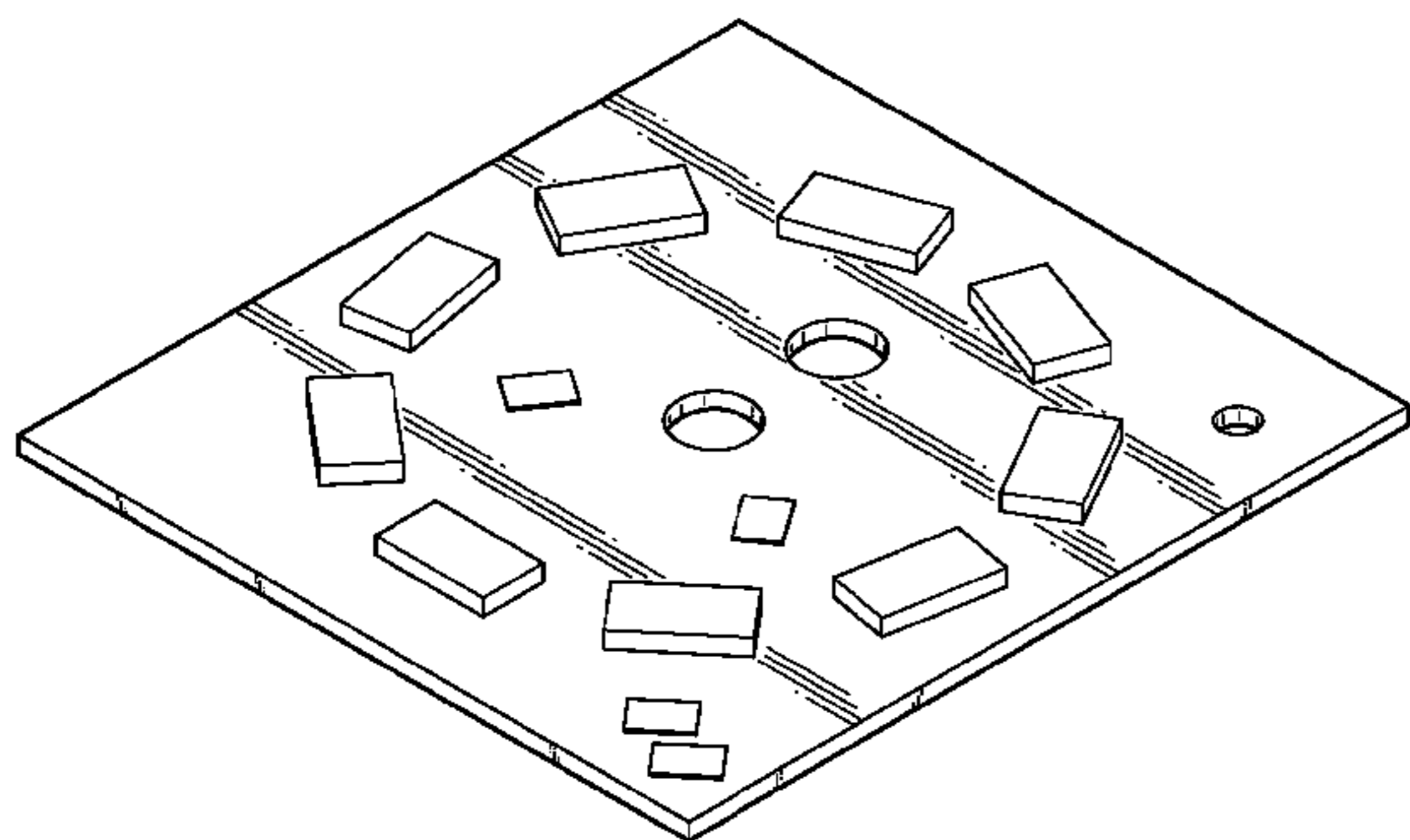
(57) **CLAIM**

The ornamental design for a light emitting diode module, as shown and described.

**DESCRIPTION**

FIG. 1 is a front perspective view of a light emitting diode module showing the new design;  
 FIG. 2 is a front elevational view thereof;  
 FIG. 3 is a rear elevational view thereof;  
 FIG. 4 is a left side elevational view thereof;  
 FIG. 5 is a right side elevational view thereof;  
 FIG. 6 is a top plan view thereof;  
 FIG. 7 is a bottom plan view thereof.  
 FIG. 8 is a front perspective view of a second embodiment of a light emitting diode module shown in FIG. 1;  
 FIG. 9 is a front elevational view of the second embodiment;  
 FIG. 10 is a rear elevational view of the second embodiment;  
 FIG. 11 is a left side elevational view of the second embodiment;  
 FIG. 12 is a right side elevational view of the second embodiment;  
 FIG. 13 is a top plan view of the second embodiment  
 FIG. 14 is a bottom plan view of the second embodiment.  
 FIG. 15 is a front perspective view of a third embodiment of a light emitting diode module shown in FIG. 1  
 FIG. 16 is a front elevational view of the third embodiment;  
 FIG. 17 is a rear elevational view of the third embodiment;  
 FIG. 18 is a left side elevational view of the third embodiment;  
 FIG. 19 is a right side elevational view of the third embodiment;  
 FIG. 20 is top plan view of the third embodiment; and,  
 FIG. 21 is bottom plan view of the third embodiment.

**1 Claim, 21 Drawing Sheets**



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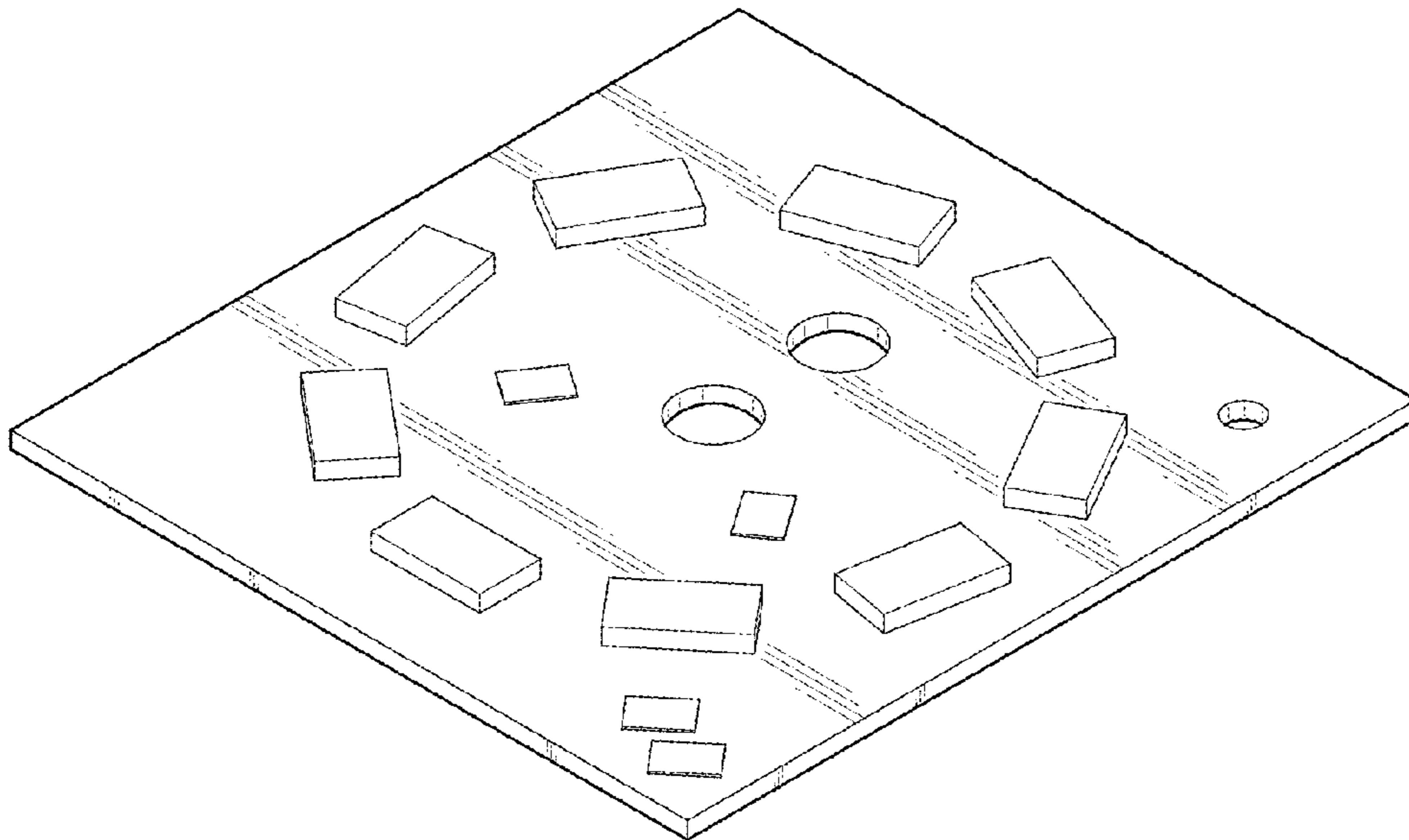


FIG. 1

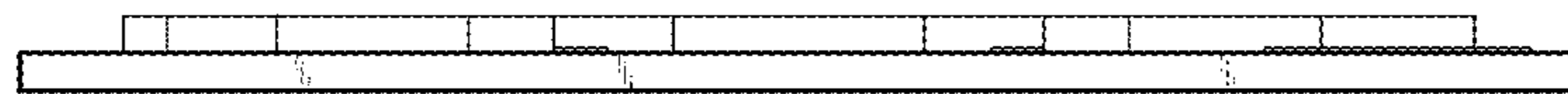


FIG.2

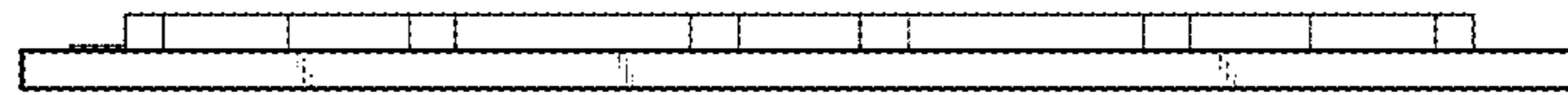


FIG.3

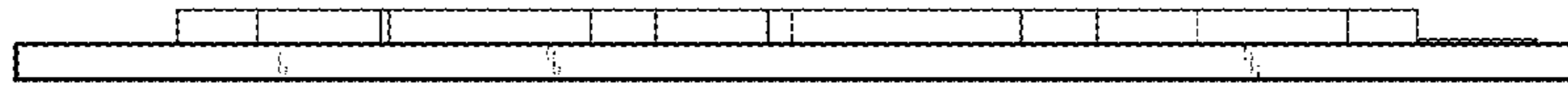


FIG.4

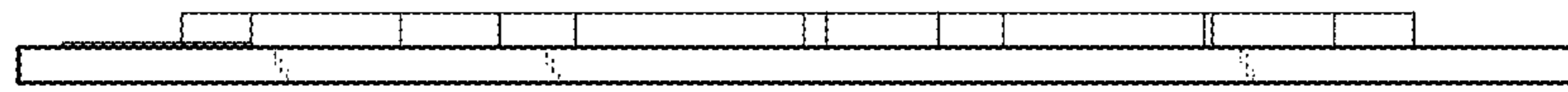


FIG.5

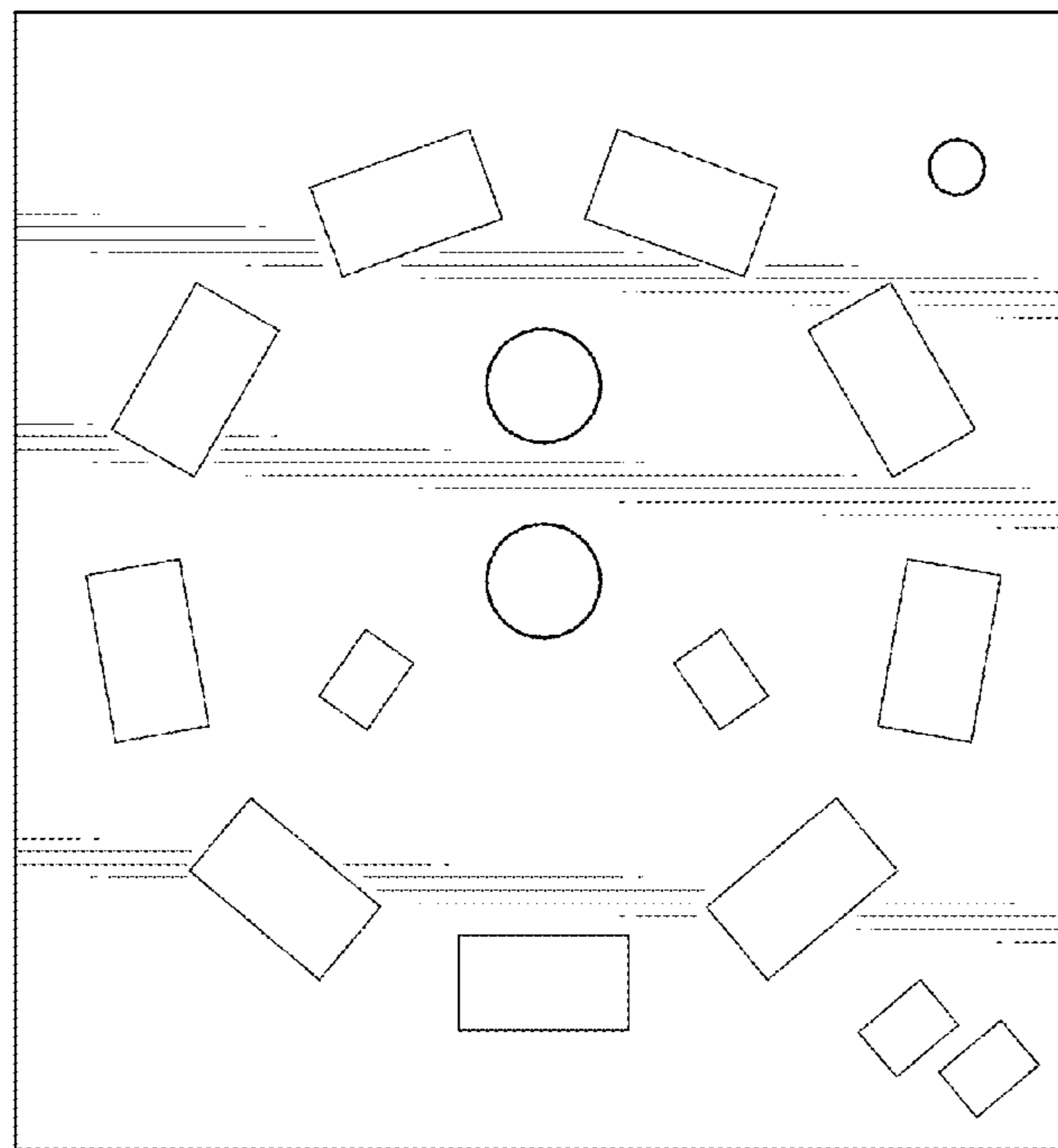


FIG.6



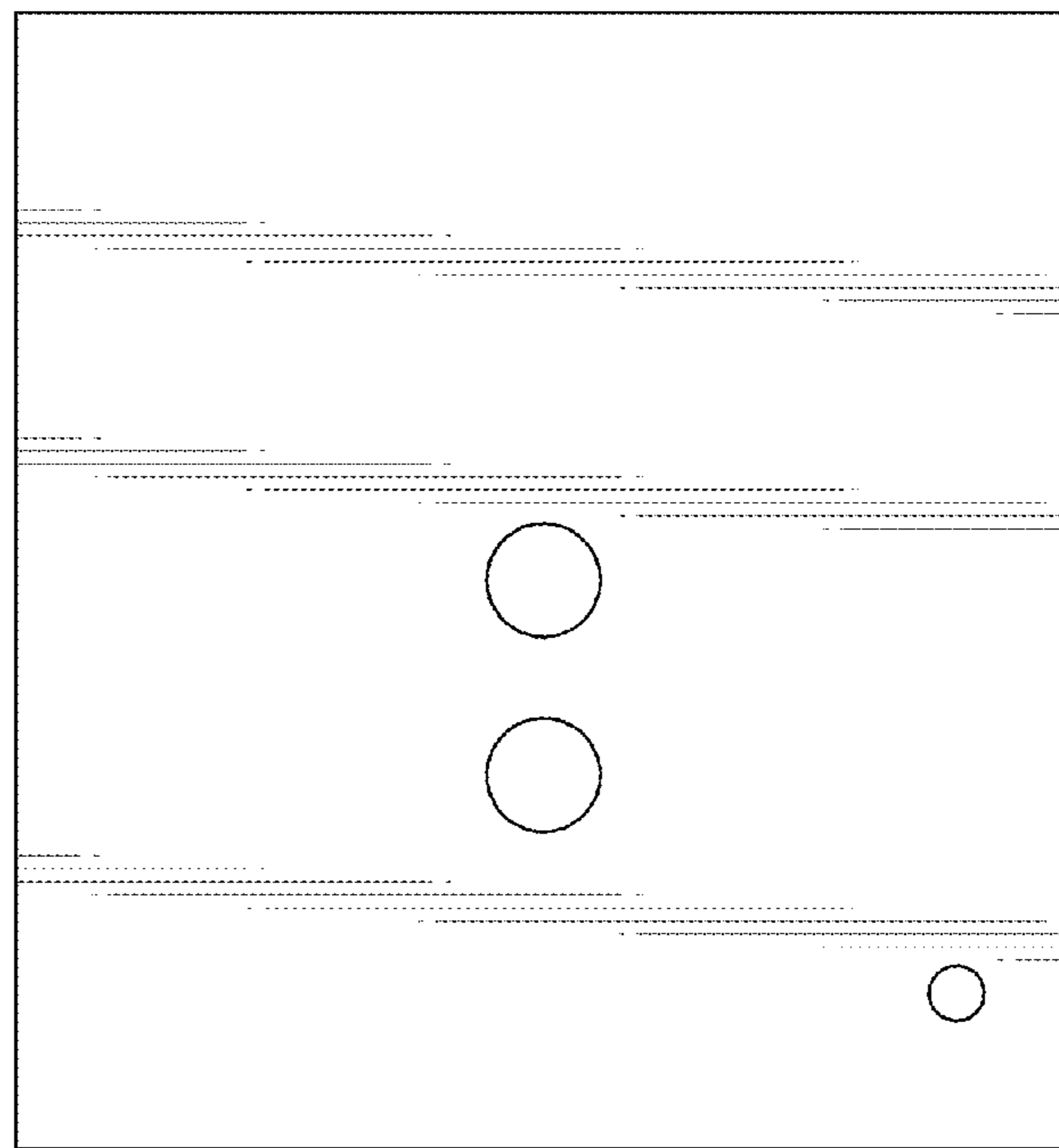


FIG. 7

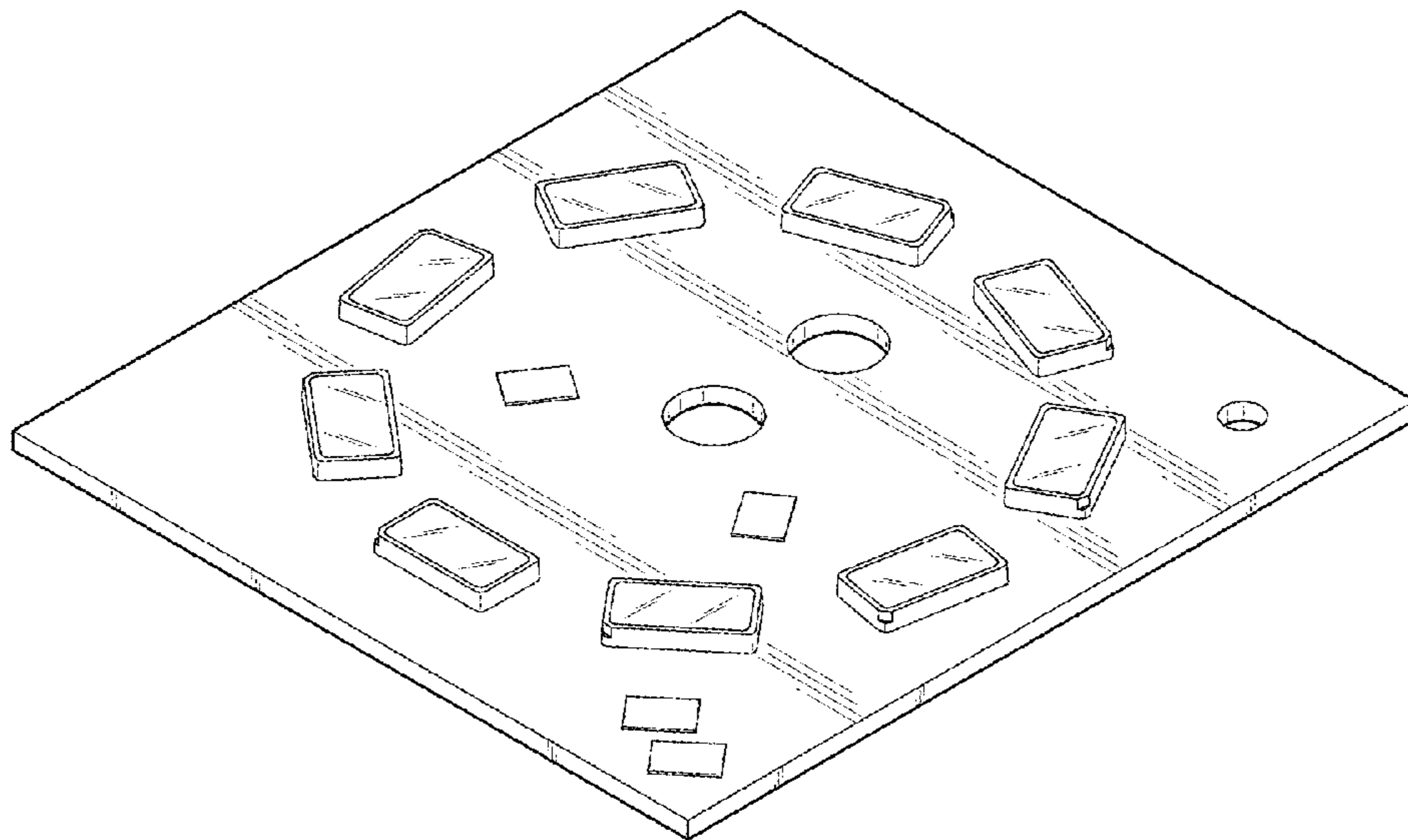


FIG. 8

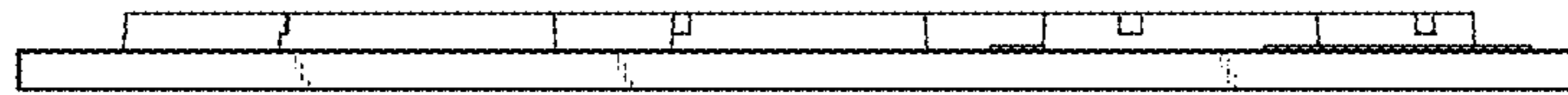


FIG.9

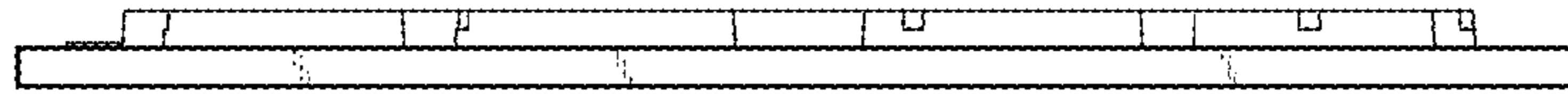


FIG. 10

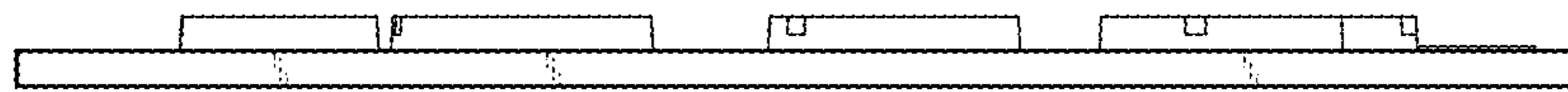


FIG.11

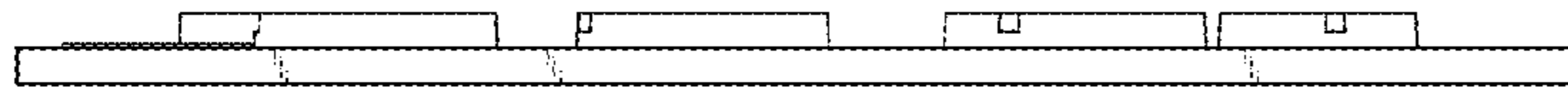


FIG.12

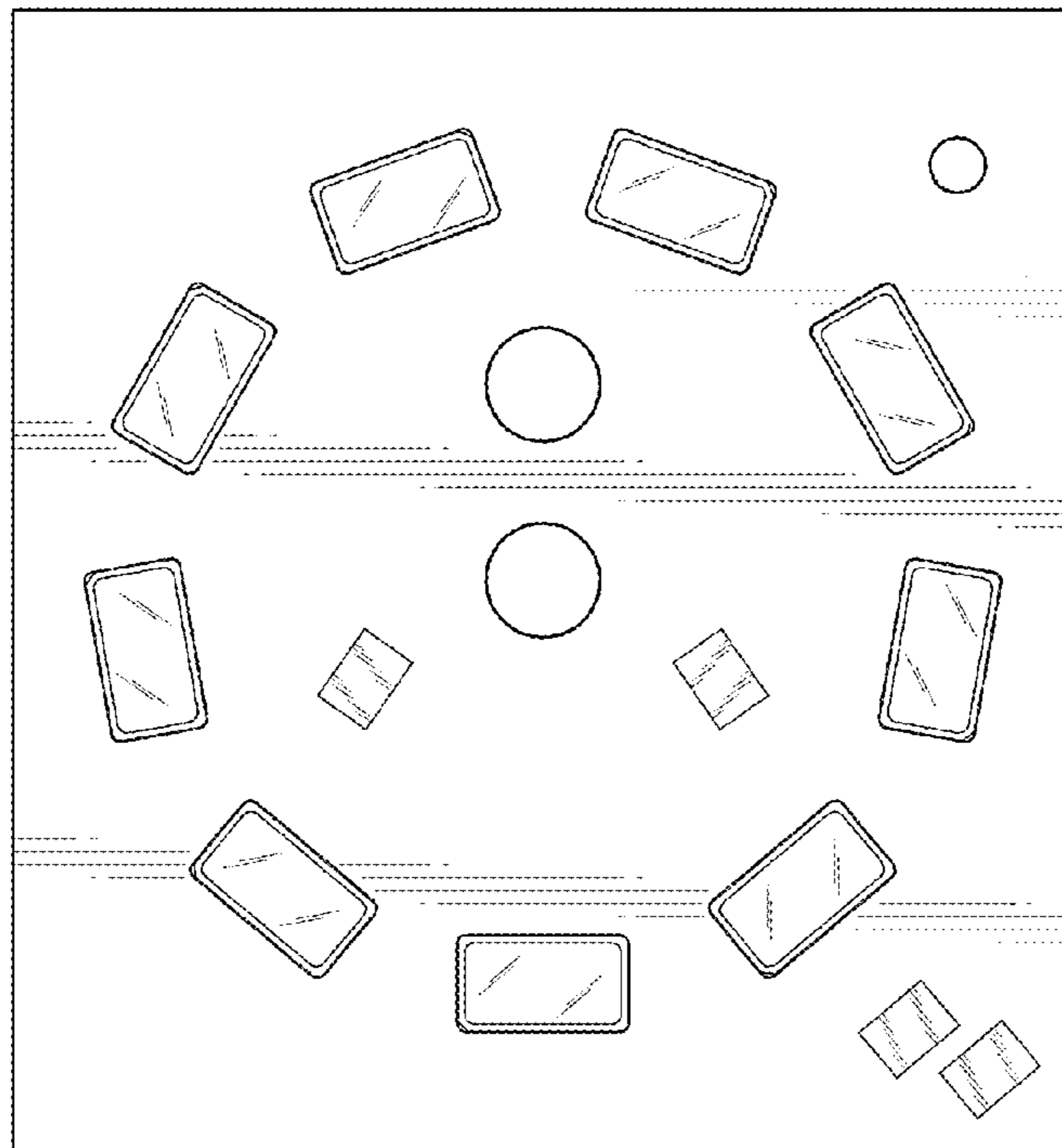


FIG. 13

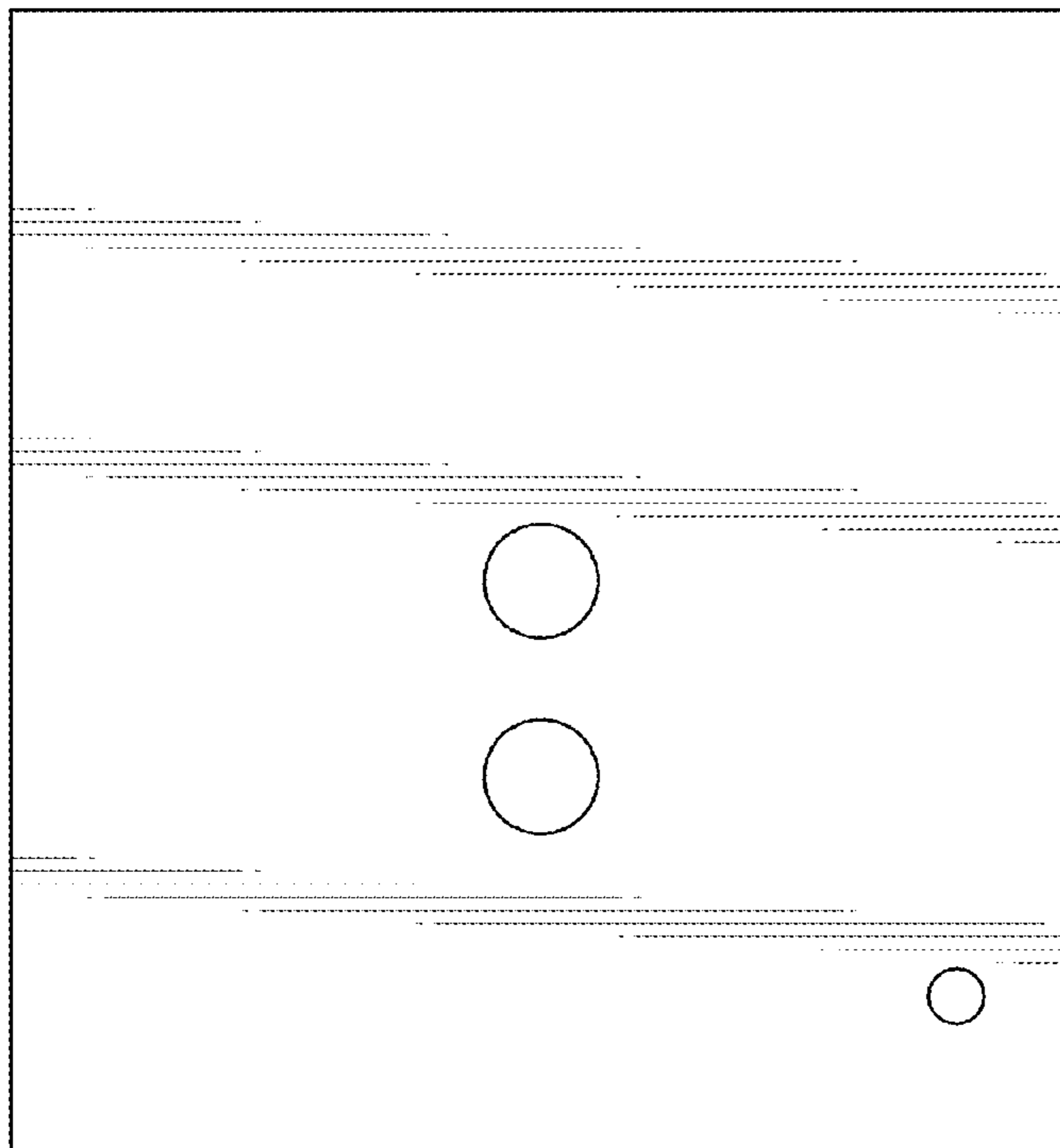


FIG. 14



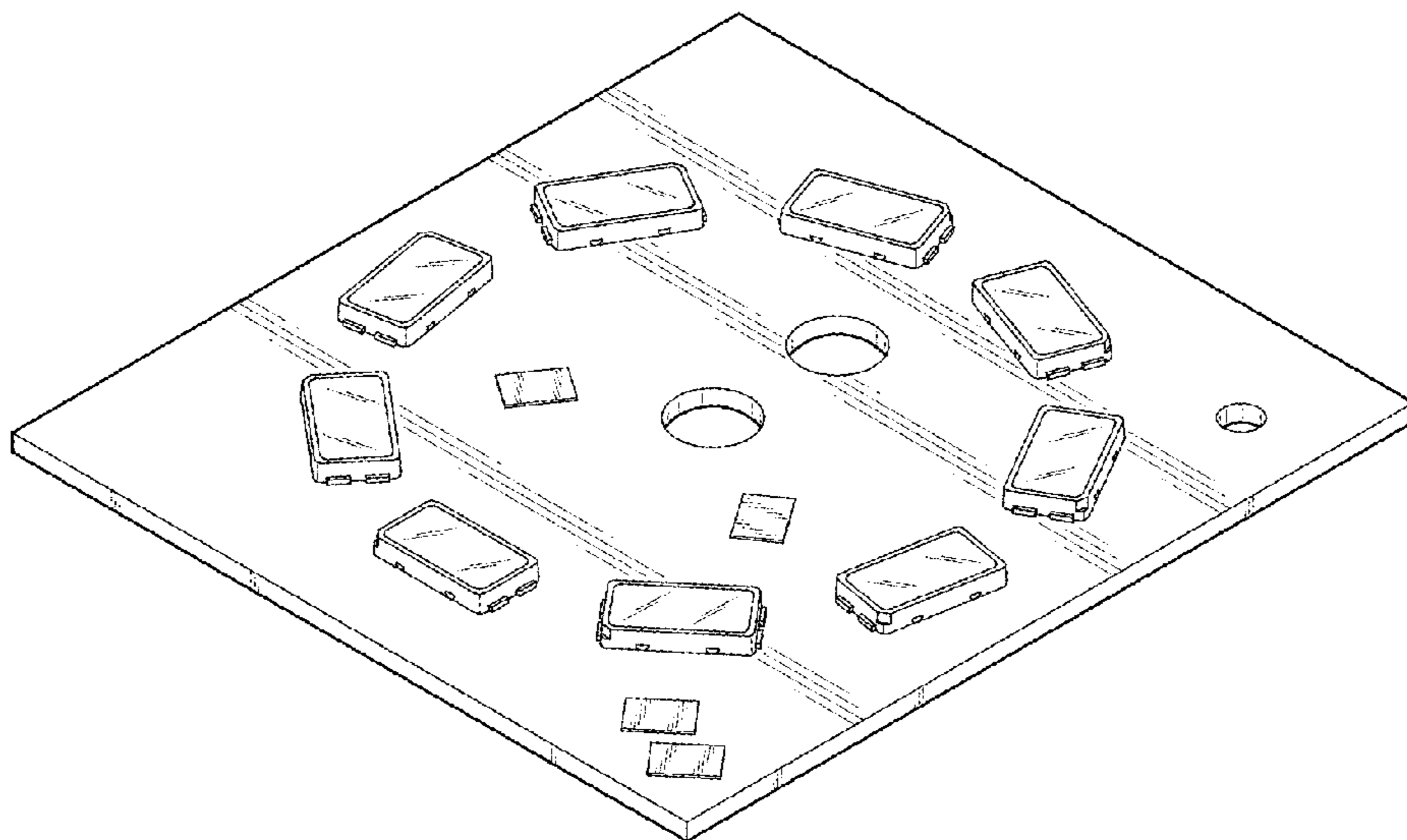


FIG. 15

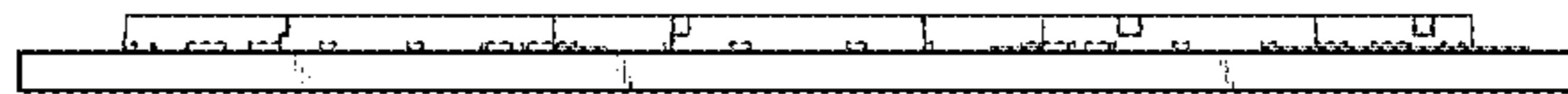


FIG.16

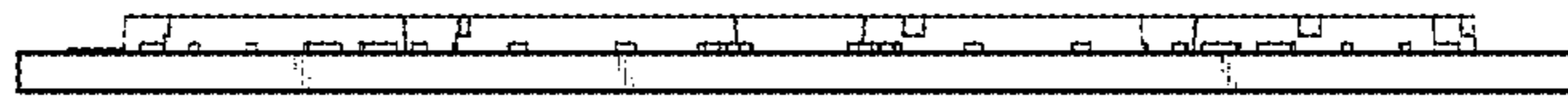


FIG.17



FIG.18

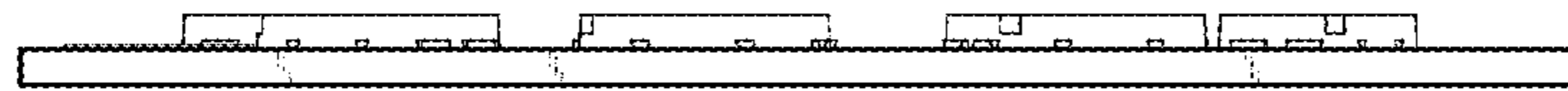


FIG.19

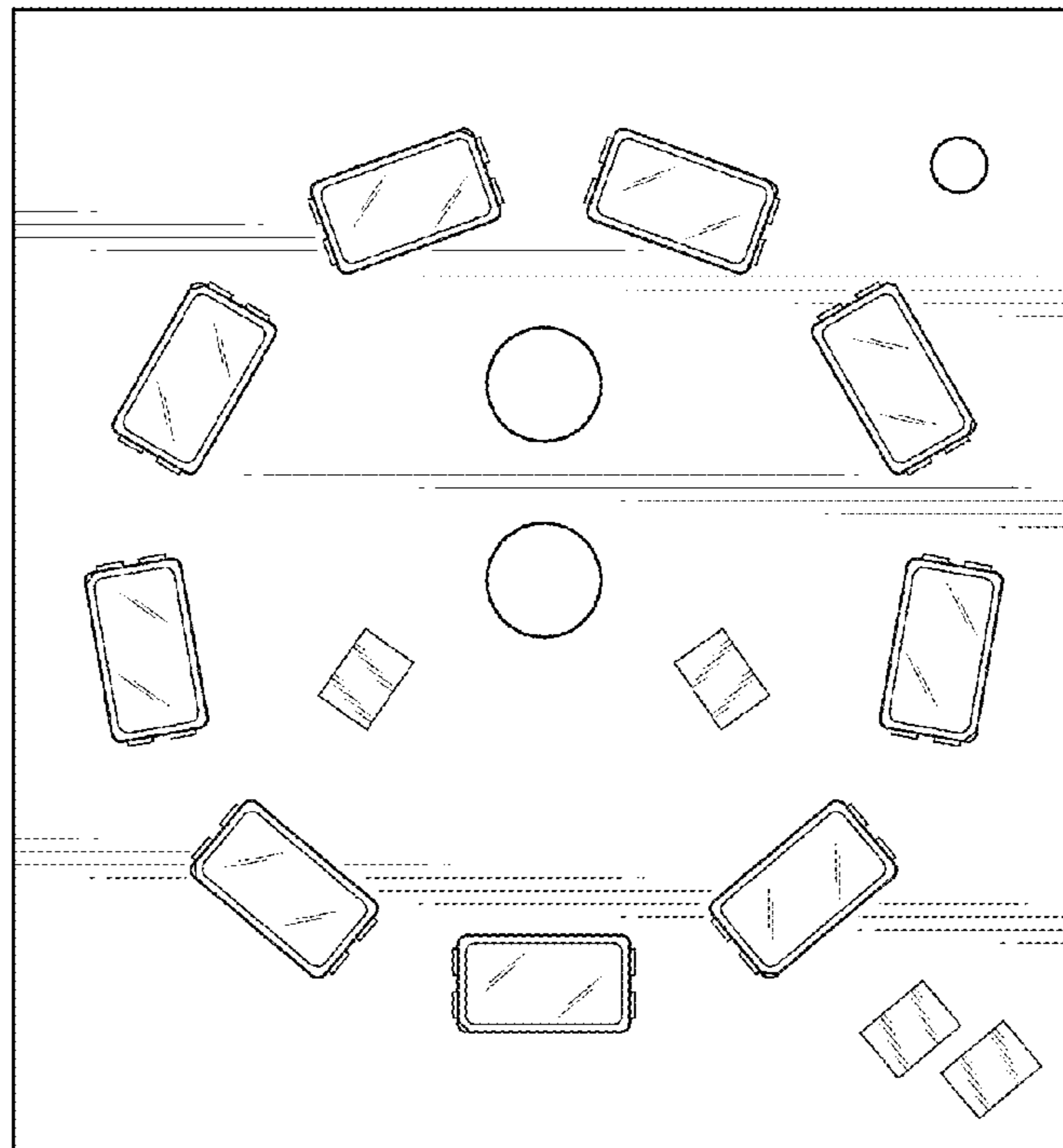


FIG.20

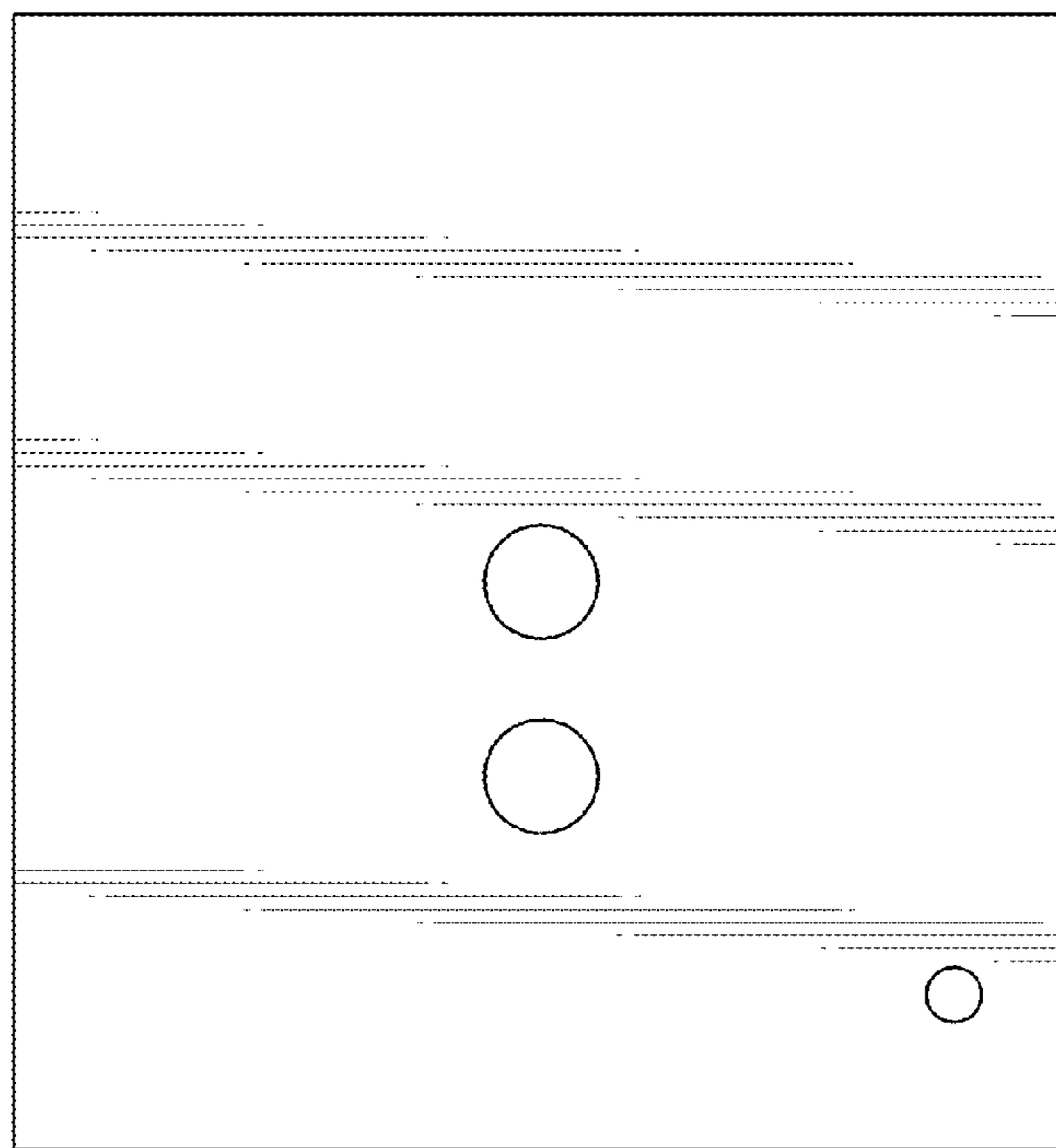


FIG. 21